

PREFACE

Dear Distinguished Delegates and Guests,

2nd International Conference on Green Power, Materials and Manufacturing Technology and Applications (GPMMTA2012) was held in Kunming, China, from July 17-19, 2012, serving as a platform for expertise exchange. GPMMTA 2012 had drawn the attention of researchers from various disciplines: Sustainable Power, Sustainable Materials, Green Manufacturing Technology and Applications, etc.

Persons who attended the conference were engineers, scientists, managers of various companies and professors of the universities abroad and home. We have had record number of submission 632 this year. From which 181 papers have been accepted for presentation at the conference and will be published by TTP, in Advanced Materials Research (AMR) Journal (ISSN: 1022-6680), which is online available in full text via the platform www.scientific.net. AMR should be indexed by EI according the previous TTP index results.

We express our special gratitude to all the members of the General Committee Chairs, Program Committee Chairs, Technical Program Committee and Steering Committee who worked so hard to prepare the conference and who supported the conference so professionally.

International Conference on Green Power, Materials and Manufacturing Technology and Applications (GPMMTA2012) is organized by Southwest Forestry University, Electric Power Research Institute of YNPG, Guizhou University, Yunnan Normal University, Jinan University, Tsinghua University, Wuhan Institute of Technology, Shanxi University of Traditional Chinese Medicine and sponsored by National Natural Science Foundation of China (NSFC). Their kind support makes GPMMTA 2012 become possible. Especially, we should thank the TTP.

Finally, we would like to thank all the authors, speakers and participants of this conference for taking part in and contributing to the International Conference on Green Power, Materials and Manufacturing Technology and Applications.

We hope you have a unique, rewarding and enjoyable week at GPMMTA2012 in Kunming, China.

With our warmest regards,

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July 17-19, 2012

Kunming, China

GPMMTA 2012

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